FDS6680A

July 2012

SEMICONDUCTOR

FDS6680A

Single N-Channel, Logic Level, PowerTrench[®] MOSFET

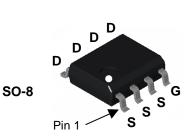
General Description

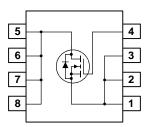
This N-Channel Logic Level MOSFET is produced using Fairchild Semiconductor's advanced Power Trench process that has been especially tailored to minimize the on-state resistance and yet maintain superior switching performance.

These devices are well suited for low voltage and battery powered applications where low in-line power loss and fast switching are required.

Features

- 12.5 A, 30 V $R_{DS(ON)} = 9.5 \text{ m}\Omega @ V_{GS} = 10 \text{ V}$ $R_{DS(ON)} = 13 \text{ m}\Omega @ V_{GS} = 4.5 \text{ V}$
- Ultra-low gate charge
- + High performance trench technology for extremely low $R_{\text{DS}(\text{ON})}$
- High power and current handling capability





Absolute Maximum Ratings TA=25°C unless otherwise noted

Symbol	Parameter		Ratings	Units
V _{DSS}	Drain-Source Voltage		30	V
V _{GSS}	Gate-Source Voltage		±20	
I _D	Drain Current – Continuous	(Note 1a)	12.5	A
	– Pulsed		50	
P _D	Power Dissipation for Single Operation	(Note 1a)	2.5	W
		(Note 1b)	1.2	
		(Note 1c)	1.0	
T _J , T _{STG}	Operating and Storage Junction Temperat	ture Range	-55 to +150	°C

Thermal Characteristics

$R_{ hetaJA}$	Thermal Resistance, Junction-to-Case	(Note 1a)	50	°C/W
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case	(Note 1)	25	

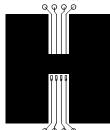
Package Marking and Ordering Information

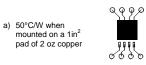
Device Marking	Device	Reel Size	Tape width	Quantity
FDS6680A	FDS6680A	13"	12mm	2500 units

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Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
	acteristics			176	шах	Unite
BV _{DSS}	Drain–Source Breakdown Voltage	$V_{GS} = 0 V$, $I_{D} = 250 \mu A$	30			V
<u>ΔBV_{DSS}</u> ΔT _J	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, Referenced to 25°C		25		mV/°C
	Zero Gate Voltage Drain Current	$V_{DS} = 24 V$, $V_{GS} = 0 V$			1	μA
		$V_{DS} = 24 V$, $V_{GS} = 0 V$, $T_J = 55^{\circ}C$			10	μA
I _{GSS}	Gate-Body Leakage	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$			±100	nA
On Chara	acteristics (Note 2)					
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$	1	2	3	V
$\Delta V_{GS(th)}$ ΔT_J	Gate Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu A$, Referenced to $25^{\circ}C$		-4.9		mV/°C
R _{DS(on)}	Static Drain–Source On–Resistance	$ \begin{array}{ll} V_{GS} = 10 \ V, & I_D = 12.5 \ A \\ V_{GS} = 4.5 \ V, & I_D = 10.5 \ A \\ V_{GS} = 10 \ V, & I_D = 12.5 \ A, \ T_J = 125^\circ C \end{array} $		7.8 9.9 11.0	9.5 13 15	mΩ
I _{D(on)}	On–State Drain Current	$V_{GS} = 10 \text{ V}, V_{DS} = 5 \text{ V}$	25			Α
g _{FS}	Forward Transconductance	$V_{DS} = 15 V$, $I_{D} = 12.5 A$		64		S
Dvnamic	Characteristics					
C _{iss}	Input Capacitance	$V_{DS} = 15 V$, $V_{GS} = 0 V$,		1620	1	pF
C _{oss}	Output Capacitance	f = 1.0 MHz		380		pF
C _{rss}	Reverse Transfer Capacitance	7		160		pF
R _G	Gate Resistance	$V_{GS} = 15 \text{ mV}, \text{ f} = 1.0 \text{ MHz}$		1.3		Ω
Switchin	g Characteristics (Note 2)					
t _{d(on)}	Turn–On Delay Time	$V_{DD} = 15 V$, $I_D = 1 A$,		10	19	ns
t _r	Turn–On Rise Time	$V_{GS} = 10 \text{ V}, \qquad R_{GEN} = 6 \Omega$		5	10	ns
t _{d(off)}	Turn-Off Delay Time	1 [27	43	ns
t _f	Turn–Off Fall Time			15	27	ns
Qg	Total Gate Charge	$V_{DS} = 15 V$, $I_D = 12.5 A$,		16	23	nC
Q _{gs}	Gate-Source Charge	$V_{GS} = 5 V$		5		nC
Q_{gd}	Gate-Drain Charge			5.8		nC
Drain-So	ource Diode Characteristics	and Maximum Ratings			. –	
ls	Maximum Continuous Drain–Sourc	e Diode Forward Current			2.1	А
V _{SD}	Drain–Source Diode Forward Voltage	$V_{GS} = 0 V, I_S = 2.1 A$ (Note 2)		0.73	1.2	V
t _{rr}	Diode Reverse Recovery Time	$I_F = 12.5 \text{ A}, d_{iF}/d_t = 100 \text{ A}/\mu\text{s}$		28		ns
Q _{rr}	Diode Reverse Recovery Charge			18		nC

 R_{8JA} is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. R_{8JC} is guaranteed by design while R_{8CA} is determined by the user's board design.



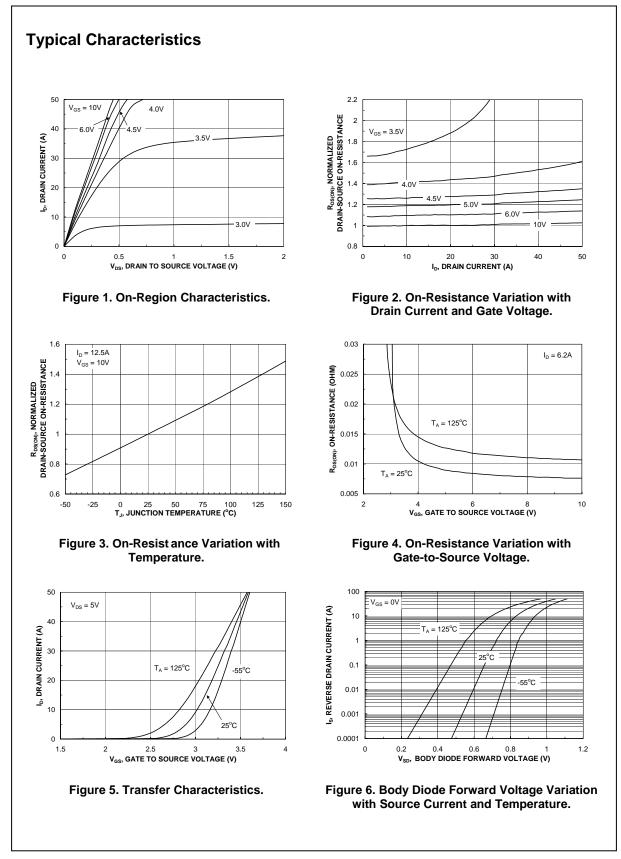


b) 105°C/W when mounted on a .04 in² pad of 2 oz copper c) 125°C/W when mounted on a minimum pad.

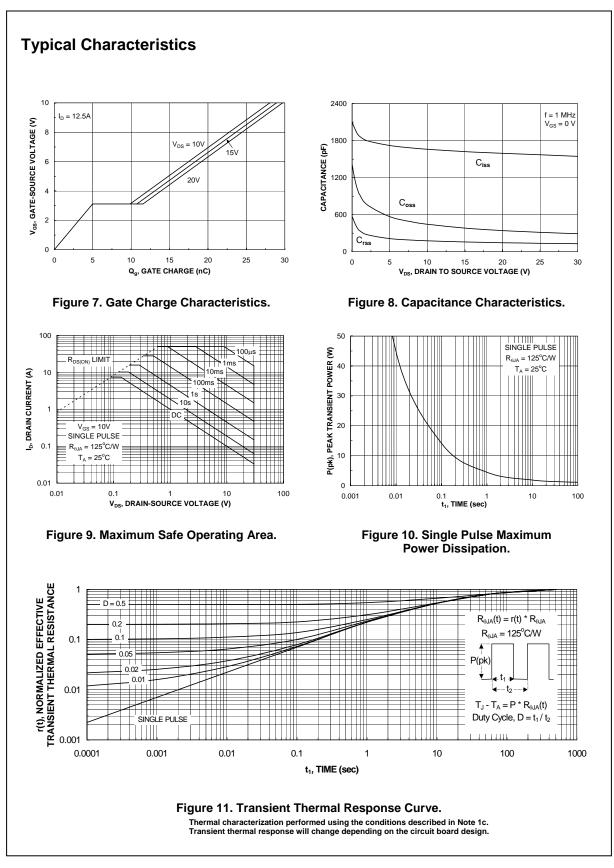
Scale 1 : 1 on letter size paper

2. Pulse Test: Pulse Width < 300μ s, Duty Cycle < 2.0%

FDS6680A



FDS6680A



FDS6680A

FDS6680A Rev F2(W)



The Power Franchise[®]

wer

franchise TinyBoost™

TinyBuck™

TinyCalc™

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